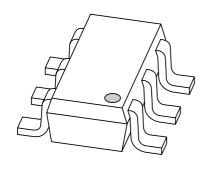
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS5350D50 V low V_{CEsat} PNP transistor

Product data sheet Supersedes data of 2001 Jul 13 2001 Nov 13



50 V low V_{CEsat} PNP transistor

PBSS5350D

FEATURES

- Low collector-emitter saturation voltage
- · High current capability
- Improved device reliability due to reduced heat generation
- Replacement for SOT89/SOT223 standard packaged transistors due to enhanced performance.

APPLICATIONS

- Supply line switching circuits
- Battery management applications
- DC/DC convertor applications
- · Strobe flash units
- Heavy duty battery powered equipment (motor and lamp drivers).

DESCRIPTION

PNP low V_{CEsat} transistor in a SC-74 (SOT457) plastic package.

NPN complement: PBSS4350D.

MARKING

TYPE NUMBER	MARKING CODE		
PBSS5350D	53		

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-50	٧
I _C	collector current (DC)	-3	Α
I _{CM}	peak collector current	-5	Α
R _{CEsat}	equivalent on-resistance	<150	mΩ

PINNING

PIN	DESCRIPTION
1	collector
2	collector
3	base
4	emitter
5	collector
6	collector

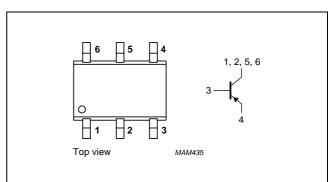


Fig.1 Simplified outline (SC-74; SOT457) and symbol.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-60	V
V _{CEO}	collector-emitter voltage	open base	_	-50	V
V _{EBO}	emitter-base voltage	open collector	_	-6	V
I _C	collector current (DC)		_	-3	Α
I _{CM}	peak collector current		_	-5	Α
I _{BM}	peak base current		_	-1	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	600	mW
		T _{amb} ≤ 25 °C; note 2	_	750	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 1 cm².
- 2. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 6 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to	in free air; note 1	208	K/W
	ambient	in free air; note 2	160	K/W

Notes

- 1. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 1 cm².
- 2. Device mounted on a printed-circuit board, single sided copper, tinplated and mounting pad for collector 6 cm².

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

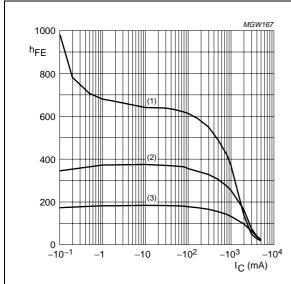
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0$	-	_	-100	nA
		$V_{CB} = -50 \text{ V}; I_E = 0; T_j = 150 ^{\circ}\text{C}$	-	-	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	-	_	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	200	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note 1}$	200	-	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}; \text{ note 1}$	100	-	_	
V _{CEsat}	collector-emitter saturation	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	-	-	-100	mV
	voltage	$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	_	-180	mV
		$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	-	-	-300	mV
R _{CEsat}	equivalent on-resistance	$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	-	120	<150	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	_	-1.2	V
V _{BE}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note 1}$	_	_	-1.1	V
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V}; f = 100 \text{ MHz}$	100	_	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	-		40	pF

Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

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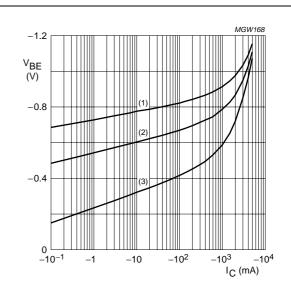
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 $V_{CE} = -2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

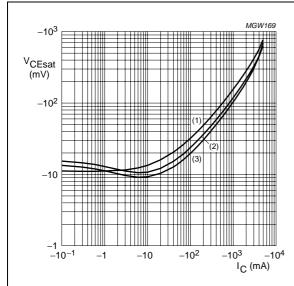
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = -2 V$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

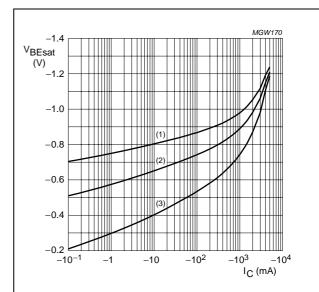
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 10.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



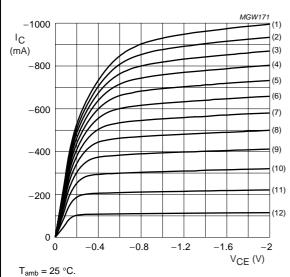
 $I_{\rm C}/I_{\rm B} = 10.$

- (1) $T_{amb} = -55 \, ^{\circ}C.$
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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(1) $I_B = -3.96 \text{ nA}.$

(5) $I_B = -2.64 \text{ nA}.$

(9) $I_B = -1.32 \text{ nA}.$

(2) $I_B = -3.63 \text{ nA}.$

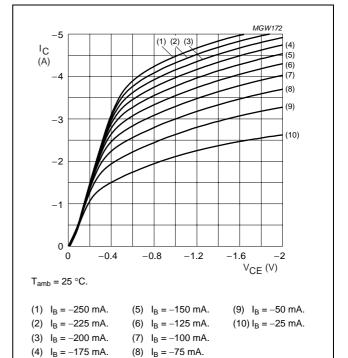
(6) $I_B = -2.31 \text{ nA}.$ (7) $I_B = -1.98 \text{ nA}.$ (10) $I_B = -0.99 \text{ nA}$.

(3) $I_B = -3.30 \text{ nA}.$ (4) $I_B = -2.97 \text{ nA}.$

(8) $I_B = -1.65 \text{ nA}.$

(11) $I_B = -0.66 \text{ nA}$. (12) $I_B = -0.33 \text{ nA}$.

Collector current as a function of collector-emitter voltage; typical values.



Collector current as a function of collector-emitter voltage; typical values.

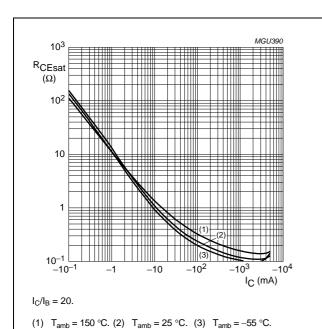


Fig.8 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

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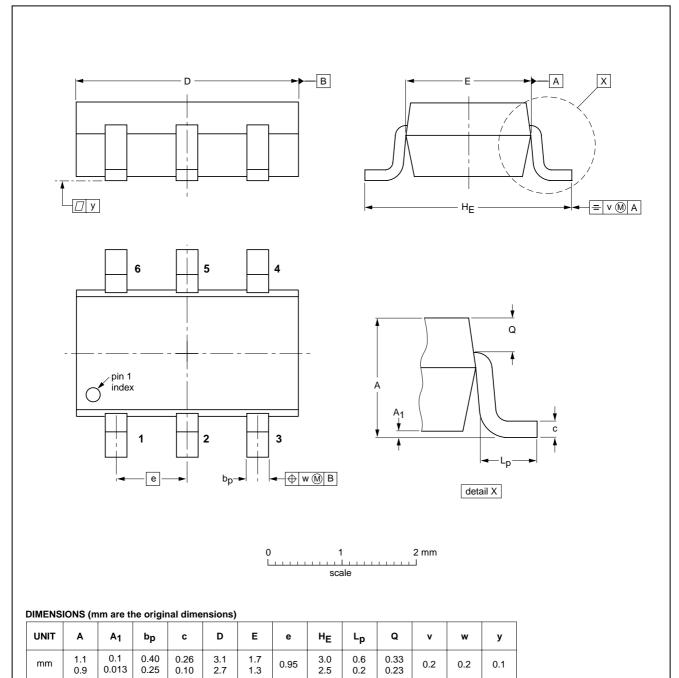
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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT457



OUTLINE	REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT457			SC-74			-97-02-28- 01-05-04

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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